- Complete PCM Codec and Filtering **Systems Include:** 
  - Transmit High-Pass and Low-Pass Filtering
  - Receive Low-Pass Filter With (sin x)/x Correction
  - Active RC Noise Filters
  - μ-Law or A-Law Compatible Coder and
  - Internal Precision Voltage Reference
  - Serial I/O Interface
  - Internal Autozero Circuitry

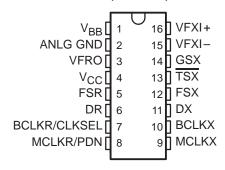
- $\mu$ -Law . . . TP3054A and TP13054A
- A-Law . . . TP3057A and TP13057A
- ±5-V Operation
- Low Operating Power . . . 50 mW Typ
- Power-Down Standby Mode . . . 3 mW Typ
- **Automatic Power Down**
- **TTL- or CMOS-Compatible Digital Interface**
- **Maximizes Line Interface Card Circuit** Density
- **Improved Versions of National** Semiconductor TP3054, TP3057, TP3054-X, TP3057-X

#### description

The TP3054A, TP3057A, TP13054A, and TP13057A are comprised of a single-chip PCM codec (pulse code-modulated encoder and decoder) and PCM line filter. These devices provide all the functions required to interface a full-duplex (2-wire) voice telephone circuit with a TDM (time-division-multiplexed) system. These devices are pin-for-pin compatible with the National Semiconductor TP3054A and TP3057A. respectively. Primary applications include:

- Line interface for digital transmission and switching of T1 carrier, PABX, and central office telephone systems
- Subscriber line concentrators
- Digital-encryption systems
- Digital voice-band data-storage systems
- Digital signal processing

**DW OR N PACKAGE** (TOP VIEW)



These devices are designed to perform the transmit encoding (A/D conversion) and receive decoding (D/A conversion) as well as the transmit and receive filtering functions in a PCM system. They are intended to be used at the analog termination of a PCM line or trunk. The devices require two transmit and receive master clocks that may be asynchronous (1.536 MHz, 1.544 MHz, or 2.048 MHz), transmit and receive data clocks that are synchronous with the master clock (but can vary from 64 kHz to 2.048 MHz), and transmit and receive frame-sync pulses. The TP3054A, TP3057A, TP13054A, and TP13057A provide the band-pass filtering of the analog signals prior to encoding and after decoding of voice and call progress tones. The TP3057A and TP13057A contain patented circuitry to achieve low transmit channel idle noise and are not recommended for applications in which the composite signals on the transmit side are below -55 dBm0.

The TP3054A and TP3057A are characterized for operation from 0°C to 70°C. The TP13054A and TP13057A are characterized for operation from -40°C to 85°C.

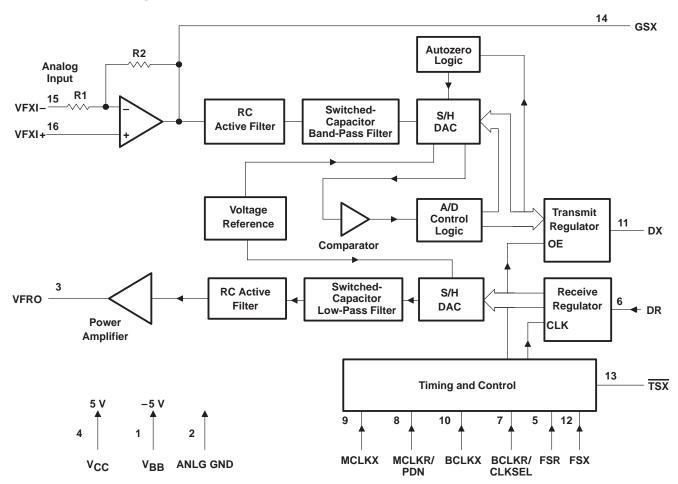


These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.



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## functional block diagram





# TP3054A, TP3057A, TP13054A, TP13057A MONOLITHIC SERIAL INTERFACE COMBINED PCM CODEC AND FILTER SCTS026C - SEPTEMBER 1992 - REVISED JULY 1996

#### **Terminal Functions**

TERMINAL		
NAME	NO.	DESCRIPTION
ANLG GND	2	Analog ground. All signals are referenced to ANLG GND.
BCLKR/CLKSEL	7	The bit clock that shifts data into DR after the FSR leading edge. May vary from 64 kHz to 2.048 MHz. Alternately, BCLKR/CLKSEL can be a logic input that selects either 1.536 MHz/1.544 MHz or 2.048 MHz for the master clock in the synchronous mode. BCLKX is used for both transmit and receive directions (see Table 1).
BCLKX	10	The bit clock that shifts out the PCM data on DX. May vary from 64 kHz to 2.048 MHz, but must be synchronous with MCLKX.
DR	6	Receive data input. PCM data is shifted into DR following the FSR leading edge.
DX	11	The 3-state PCM data output that is enabled by FSX.
FSR	5	Receive-frame sync pulse input that enables BCLKR to shift PCM data in DR. FSR is an 8-kHz pulse train (see Figures 1 and 2 for timing details).
FSX	12	Transmit-frame sync pulse that enables BCLKX to shift out the PCM data on DX. FSX is an 8-kHz pulse train (see Figures 1 and 2 for timing details).
GSX	14	Analog output of the transmit input amplifier. GSX is used to externally set gain.
MCLKR/PDN	8	Receive master clock (must be 1.536 MHz, 1.544 MHz, or 2.048 MHz). May be synchronous with MCLKX, but should be synchronous with MCLKX for best performance. When MCLKR is connected continuously low, MCLKX is selected for all internal timing. When MCLKR is connected continuously high, the device is powered down.
MCLKX	9	Transmit master clock (must be 1.536 MHz, 1.544 MHz, or 2.048 MHz). May be asynchronous with MCLKR
TSX	13	Open-drain output that pulses low during the encoder time slot
V <sub>BB</sub>	1	Negative power supply. $V_{BB} = -5 \text{ V} \pm 5\%$
VCC	4	Positive power supply. $V_{CC} = 5 \text{ V} \pm 5\%$
VFRO	3	Analog output of the receive filter
VFXI+	16	Noninverting input of the transmit input amplifier
VFXI-	15	Inverting input of the transmit input amplifier

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functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not

#### **DISSIPATION RATING TABLE**

PACKAGE	T <sub>A</sub> ≤ 25°C POWER RATING	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 85°C POWER RATING
DW	1025 mW	8.2 mW/°C	656 mW	533 mW
N	1150 mW	9.2 mW/°C	736 mW	598 mW

#### recommended operating conditions (see Note 2)

			MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>			4.75	5	5.25	V
Supply voltage, V <sub>BB</sub>			-4.75	-5	-5.25	V
High-level input voltage, VIH			2.2			V
Low-level input voltage, V <sub>IL</sub>					0.6	V
Common-mode input voltage range, V <sub>ICR</sub> ‡					±2.5	V
Load resistance, GSX, R <sub>L</sub>			10			kΩ
Load capacitance, GSX, C <sub>L</sub>					50	рF
Operating free circumparature T.		TP3054A, TP3057A			70	°C
Operating free-air temperature, T <sub>A</sub>		TP13054A, TP13057A	-40		85	J

<sup>#</sup> Measured with CMRR > 60 dB.

NOTE 2: To avoid possible damage to these CMOS devices and resulting reliability problems, the power-up procedure described in the device power-up sequence paragraphs later in this document should be followed.

# electrical characteristics over recommended ranges of supply voltage operating free-air temperature range (unless otherwise noted)

#### supply current

PARAMETER		TEST CONDITIONS	TP305xA			Т	UNIT			
		TEST CONDITIONS	MIN	TYP‡	MAX	MIN	TYP‡	MAX		
Loo Supply ourrent from Voc	Power down	No load		0.5	1		0.5	1.2	A	
ICC	ICC Supply current from VCC	Active	NO IOAU		6	9		6	10	mA
		Power down	Nolood		0.5	1		0.5	1.2	A
IBB Supply current from VBB	Active	No load		6	9		6	10	mA	



implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. NOTE 1: All voltages are with respect to GND.

# electrical characteristics at V<sub>CC</sub> = 5 V $\pm 5\%$ , V<sub>BB</sub> = -5 V $\pm 5\%$ , GND at 0 V, T<sub>A</sub> = 25°C (unless otherwise noted)

#### digital interface

	PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
Vон	High-level output voltage	DX	I <sub>H</sub> = -3.2 mA	2.4		V
V/a.	OL Low-level output voltage	DX	I <sub>L</sub> = 3.2 mA		0.4	V
VOL		TSX	I <sub>L</sub> = 3.2 mA, Drain open		0.4	V
lн	High-level input current		VI = VIH to VCC		±10	μΑ
I <sub>I</sub> L	Low-level input current	All digital inputs	V <sub>I</sub> = GND to V <sub>IL</sub>		±10	μΑ
loz	Output current in high-impedance state	DX	$V_O = GND$ to $V_{CC}$		±10	μΑ

## analog interface with transmit amplifier input

	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
Ι <sub>Ι</sub>	Input current	VFXI+ or VFXI-	$V_{I} = -2.5 \text{ V to } 2.5 \text{ V}$			±200	nA
rį	Input resistance	VFXI+ or VFXI-	$V_I = -2.5 \text{ V to } 2.5 \text{ V}$	10			МΩ
r <sub>O</sub>	Output resistance		Closed loop, Unity gain		1	3	Ω
	Output dynamic range	GSX	$R_L \ge 10 \text{ k}\Omega$			±2.8	V
Ay	Open-loop voltage amplification	VFXI+ to GSX		5000			
B <sub>l</sub>	Unity-gain bandwidth	GSX		1	2		MHz
VIO	Input offset voltage	VFXI+ or VFXI-				±20	mV
CMRR	Common-mode rejection ratio			60			dB
K <sub>SVR</sub>	Supply-voltage rejection ratio			60			dB

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC}$  = 5 V,  $V_{BB}$  = -5 V, and  $T_A$  = 25°C.

#### analog interface with receive filter

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
Output resistance	VFRO			1	3	Ω
Load resistance		VFRO = ±2.5 V	600			Ω
Load capacitance	VFRO to GND				500	pF
Output dc offset voltage	VFRO to GND				±200	mV

 $<sup>^{\</sup>dagger}$  All typical values are at V<sub>CC</sub> = 5 V, V<sub>BB</sub> = -5 V, and T<sub>A</sub> = 25°C.

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#### timing requirements

	PARAMETER	_	TEST CONDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT
fclock(M)	Frequency of master clock	MCLKX and MCLKR	Depends on the device used and BCLKX/CLKSEL		1.536 1.544 2.048		MHz
fclock(B)	Frequency of bit clock, transmit	BCLKX		64		2048	kHz
t <sub>w1</sub>	Pulse duration, MCLKX and MCLKR high	h		160			ns
t <sub>w2</sub>	Pulse duration, MCLKX and MCLKR low			160			ns
t <sub>r1</sub>	Rise time of master clock	MCLKX and MCLKR	Managered from 209/ to 909/			50	ns
<sup>t</sup> f1	Fall time of master clock	MCLKX and MCLKR	Measured from 20% to 80%			50	ns
t <sub>r2</sub>	Rise time of bit clock, transmit	BCLKX	Measured from 20% to 80%			50	ns
t <sub>f2</sub>	Fall time of bit clock, transmit	BCLKX	Measured from 20% to 80%			50	ns
t <sub>su1</sub>	Setup time, BCLKX high (and FSX in long-frame sync mode) before MCLKX $\!\!\downarrow$		First bit clock after the leading edge of FSX	100			ns
t <sub>w3</sub>	Pulse duration, BCLKX and BCLKR high	1	V <sub>IH</sub> = 2.2 V	160			ns
t <sub>W4</sub>	Pulse duration, BCLKX and BCLKR low		V <sub>IL</sub> = 0.6 V	160			ns
<sup>t</sup> h1	Hold time, frame sync low after bit clock (long frame only)	low		0			ns
t <sub>h2</sub>	Hold time, BCLKX high after frame sync↑ (short frame only)			0			ns
t <sub>su2</sub>	Setup time, frame sync high before bit cl (long frame only)	ock↓		80			ns
<sup>t</sup> d1	Delay time, BCLKX high to data valid		Load = 150 pF plus 2 LSTTL loads‡	0		140	ns
t <sub>d2</sub>	Delay time, BCLKX high to TSX low		Load = 150 pF plus 2 LSTTL loads <sup>‡</sup>			140	ns
t <sub>d3</sub>	Delay time, BCLKX (or 8 clock FSX in low to data output disabled	ng frame only)		50		165	ns
t <sub>d4</sub>	Delay time, FSX or BCLKX high to data v frame only)	valid (long	C <sub>L</sub> = 0 pF to 150 pF	20		165	ns
t <sub>su3</sub>	Setup time, DR valid before BCLKR $\downarrow$			50			ns
t <sub>h3</sub>	Hold time, DR valid after BCLKR or BCL	κχ↓		50			ns
t <sub>su4</sub>	Setup time, FSR or FSX high before BCI BCLKR $\downarrow$	_KR or	Short-frame sync pulse (1 or 2 bit clock periods long) (see Note 3)	50			ns
t <sub>h4</sub>	Hold time, FSX or FSR high after BCLKX or BCLKR↓		Short-frame sync pulse (1 or 2 bit clock periods long) (see Note 3)	100			ns
<sup>t</sup> h5	Hold time, frame sync high after bit clock	:↓	Long-frame sync pulse (from 3 to 8 bit clock periods long)	100			ns
t <sub>w5</sub>	Minimum pulse duration of the frame syn (low level)	nc pulse	64 kbps operating mode	160			ns

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, V<sub>BB</sub> = -5 V, and T<sub>A</sub> =  $25^{\circ}$ C. ‡ Nominal input value for an LSTTL load is 18 kΩ.

NOTE 3: For short-frame sync timing, FSR and FSX must go high while their respective bit clocks are high.



operating characteristics, over operating free-air temperature range, V<sub>CC</sub> = 5 V  $\pm 5\%$ , V<sub>BB</sub> = -5 V  $\pm 5\%$ , GND at 0 V, V<sub>I</sub> = 1.2276 V, f = 1.02 kHz, transmit input amplifier connected for unity gain, noninverting (unless otherwise noted)

#### filter gains and tracking errors

PARAMETER		TEST CONDITIONS‡	MIN	TYPT MAX	UNIT		
Maximum peak transmit overload level	TP3054A, TP13054A	3.17 dBm0		2.501	V		
iviaximum peak transmit overload iever	TP3057A, TP13057A	3.14 dBm0		2.492	V		
Transmit filter gain, absolute (at 0 dBm0)		T <sub>A</sub> = 25°C	- 0.15	0.15	dB		
		f = 16 Hz		-40			
		f = 50 Hz		-30			
		f = 60 Hz		-26			
		f = 200 Hz	-1.8	-0.1			
Transmit filter gain, relative to absolute		f = 300 Hz to 3000 Hz	-0.15	0.15	dB		
Transmit filter gain, relative to absolute		f = 3300 Hz	-0.35	0.05	uБ		
		f = 3400 Hz	-0.8	0			
		f = 4000 Hz		-14			
		f ≥ 4600 Hz (measure response from 0 Hz to 4000 Hz)		-32			
Absolute transmit gain variation with temperature and supply voltage		Relative to absolute transmit gain	-0.1	0.1	dB		
		Sinusoidal test method, Reference level = -10 dBm0					
Transmit gain tracking error with level	3 dBm0 ≥ input level ≥ -40 dBm0		±0.2	dB			
		-40 dBm0 > input level ≥ -50 dBm0		±0.4	ĺ		
		-50 dBm0 > input level ≥ -55 dBm0		±0.8			
Receive filter gain, absolute (at 0 dBm0)		Input is digital code sequence for 0-dBm0 signal, T <sub>A</sub> = 25°C	-0.15	0.15	dB		
		$f = 0 H_Z \text{ to } 3000 \text{ Hz}, \qquad T_A = 25^{\circ}\text{c}$	-0.15	0.15			
Descrive filter gain, relative to absolute		f = 3300 Hz	-0.35	0.05	dB		
Receive litter gain, relative to absolute		f = 3400 Hz	-0.8	0	uБ		
		f = 4000 Hz		-14			
Absolute receive gain variation with temp voltage	perature and supply	T <sub>A</sub> = full range, See Note 4	-0.1	0.1	dB		
		Sinusoidal test method; reference input PCM code corresponds to an ideally encoded –10 dBm0 signal					
Receive gain tracking error with level		3 dBm0 ≥ input level ≥ -40 dBm0		±0.2			
		-40 dBm0 > input level ≥ -50 dBm0		±0.4			
		-50 dBm0 > input level ≥ -55 dBm0		±0.8			
Receive output drive voltage		$R_L = 10 \text{ k}\Omega$		±2.5	V		
Transmit and receive gain tracking error	with level (A-law,	Pseudo-noise test method; reference input PCM code corresponds to an ideally encoded –10 dBm0 signal			d۵		
CCITT C 712)	•	3 dBm0 ≥ input level ≥ -40 dBm0		±0.25	dB		
eceive gain tracking error with level eceive output drive voltage ransmit and receive gain tracking error with level (A-law,		-40 dBm0 > input level ≥-50 dBm0		±0.3			
ransmit gain tracking error with level  Receive filter gain, absolute (at 0 dBm0)  Receive filter gain, relative to absolute  Receive gain variation with temperature and supply oltage  Receive gain tracking error with level  Receive output drive voltage	-50 dBm0 > input level ≥ -55 dBm0		±0.45				

<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $V_{BB} = -5 \text{ V}$ , and  $T_A = 25^{\circ}\text{C}$ .



<sup>‡</sup> Absolute rms signal levels are defined as follows:  $V_1 = 1.2276 \text{ V} = 0 \text{ dBm0} = 4 \text{ dBm at f} = 1.02 \text{ kHz with R}_L = 600 \Omega$ .

NOTE 4: Full range for the TP3054A and TP3057A is 0°C to 70°C. Full range for the TP13054A and TP13057A is -40°C to 85°C.

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#### envelope delay distortion with frequency

PARAMETER	TEST CONDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT	
Transmit delay, absolute (at 0 dBm0)	f = 1600 Hz		290	315	μs	
	f = 500 Hz to 600 Hz		195	220		
	f = 600 Hz to 800 Hz		120	145		
	f = 800 Hz to 1000 Hz		50	75		
Transmit delay, relative to absolute	f = 1000 Hz to 1600 Hz		20	40	μs	
	f = 1600 Hz to 2600 Hz		55	75		
	f = 2600 Hz to 2800 Hz		80	105		
	f = 2800 Hz to 3000 Hz	290 315 µ 195 220 120 145 50 75 20 40 55 75 80 105 130 155 180 200 µ -40 -25 -30 -20				
Receive delay, absolute (at 0 dBm0)	f = 1600 Hz		180	200	μs	
	f = 500 Hz to 1000 Hz	-40	-25			
	f = 1000 Hz to 1600 Hz	-30	-20			
Receive delay, relative to absolute	f = 1600 Hz to 2600 Hz		70	90	μs	
	f = 2600 Hz to 2800 Hz		100	125		
	f = 2800 Hz to 3000 Hz		140	175		

#### noise

PARAMETER		TEST CONDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT
Transmit noise, C-message weighted	TP3054A, TP13054A	VFXI = 0 V		9	14	dBrnC0
Transmit noise, psophometric weighted (see Note 5)	TP3057A, TP13057A	VFXI = 0 V		-78	-75	dBm0p
Receive noise, C-message weighted	TP3054A, TP13054A	PCM code equals alternating positive and negative zero		2	4	dBrnC0
Receive noise, psophometric weighted	TP3057A, TP13057A	PCM code equals positive zero		-86	-83	dBm0p
Noise, single frequency		VFXI+ = 0 V, f = 0 kHz to 100 kHz, Loop-around measurement			-53	dBm0

 $<sup>^{\</sup>dagger}$  All typical values are at V<sub>CC</sub> = 5 V, V<sub>BB</sub> = -5 V, and T<sub>A</sub> = 25°C.

NOTE 5: Measured by extrapolation from the distortion test result. This parameter is achieved through use of patented circuitry and is not recommended for applications in which the composite signals on the transmit side are below -55 dBm0.



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#### power supply rejection

PARAMETER	TEST CONI	DITIONS		MIN	MAX	UNIT
		f _ 0 Hz to 4 kHz	A-law	38		dB
Positive power-supply rejection, transmit	V <sub>CC</sub> = 5 V + 100 mVrms, VFXI+ = -50 dBm0	T = 0 HZ t0 4 KHZ	μ-law	38		dBC†
	VIXII = 30 dBiilo	$ \begin{array}{ll} +\ 100\ \text{mVrms}, \\ 0\ \text{dBm0} \end{array} \qquad \begin{array}{ll} f = 0\ \text{Hz to }4\ \text{kHz} \end{array} \qquad \begin{array}{ll} \mu \cdot \\ f = 4\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} f = 0\ \text{Hz to }4\ \text{kHz} \end{array} \qquad \begin{array}{ll} \mu \cdot \\ f = 4\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} f = 0\ \text{Hz to }4\ \text{kHz} \end{array} \qquad \begin{array}{ll} A \\ \mu \cdot \\ f = 4\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} f = 0\ \text{Hz to }4\ \text{kHz} \end{array} \qquad \begin{array}{ll} A \\ \mu \cdot \\ f = 4\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} f = 0\ \text{Hz to }4\ \text{kHz} \end{array} \qquad \begin{array}{ll} A \\ \mu \cdot \\ f = 4\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} f = 0\ \text{Hz to }4\ \text{kHz} \end{array} \qquad \begin{array}{ll} A \\ \mu \cdot \\ f = 4\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 4\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 4\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 4\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 4\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 4\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 4\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} \end{array} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} $ $ \begin{array}{ll} A \\ \mu \cdot \\ f = 6\ \text{kHz to }50\ \text{kHz} $		40		dB
		f 0.11= to 4.14.1=	A-law	35		dB
Negative power-supply rejection, transmit	$V_{BB} = -5 \text{ V} + 100 \text{ mVrms},$ $V_{FXI} = -50 \text{ dBm0}$	T = 0 HZ t0 4 KHZ	μ-law	35		dBC†
	VI XII = -30 UBIII0	f = 4 kHz to 50 kHz		40		dB
Positive power-supply rejection, receive	PCM code equals positive zero, V <sub>CC</sub> = 5 V + 100 mVrms	f = 0 Hz to 4 kHz	A-law	40		dB
			μ-law	40		dBC <sup>†</sup>
		f = 4 kHz to 50 kHz		40		dB
		f 011= to 4141=	A-law	38		dB
Negative power-supply rejection, receive	PCM code equals positive zero, VBB = -5 V + 100 mVrms	1 = 0 HZ t0 4 KHZ	μ-law	38		dBC†
	ABB = -2 A + 100 III AIIII 8	$\begin{array}{c} 1000 \text{ mVrms,} \\ 0 \text{ dBm0} \end{array} \qquad \begin{array}{c} f = 0 \text{ Hz to } 4 \text{ kHz} & \begin{array}{c} A\text{-law} \\ \mu\text{-law} & 38 \\ \end{array} \\ f = 4 \text{ kHz to } 50 \text{ kHz} & \begin{array}{c} 40 \\ \end{array} \\ + 100 \text{ mVrms,} \\ 0 \text{ dBm0} \end{array} \qquad \begin{array}{c} f = 0 \text{ Hz to } 4 \text{ kHz} \\ \end{array} \qquad \begin{array}{c} A\text{-law} & 35 \\ \mu\text{-law} & 35 \\ \end{array} \\ f = 4 \text{ kHz to } 50 \text{ kHz} & \begin{array}{c} 40 \\ \end{array} \\ \end{array} \qquad \begin{array}{c} A\text{-law} & 35 \\ \mu\text{-law} & 35 \\ \end{array} \\ \begin{array}{c} f = 0 \text{ Hz to } 4 \text{ kHz} \\ \end{array} \qquad \begin{array}{c} A\text{-law} & 40 \\ \end{array} \\ \begin{array}{c} A\text{-law} & 38 \\ \end{array} \\ $	dB			
	0 dBm0, 300-Hz to 3400-Hz input ap image signals at VFRO)		-30	dB		
ı ·	f = 4600 Hz to 7600 Hz					
Charmer output (VFRO)	f = 7600 Hz to 8400 Hz				-40	dB
Positive power-supply rejection, receive	f = 8400 Hz to 100 kHz				-40	

#### distortion

PARAMETER	TEST CONDITIONS		MIN	MAX	UNIT
Signal-to-distortion ratio, transmit or receive half-channel‡	Level = 3 dBm0		33		
	Level = 0 dBm0 to -30 dBm0		36		
	Level = -40 dBm0	Transmit	29		dBC†
		Receive	30		
	Level = -55 dBm0	Transmit	14		
		Receive	15		
Single-frequency distortion products, transmit				-46	dB
Single-frequency distortion products, receive				-46	dB
Intermodulation distortion	Loop-around measurement,  VFXI+ = -4 dBm0 to -21 dBm0,  Two frequencies in the range of 300 Hz to 3400 Hz			-41	dB
Signal-to-distortion ratio, transmit half-channel (A-law) (CCITT G.714)§	Level = -3 dBm0		33		dB
	Level = -6 dBm0 to -27 dBm0		36		
	Level = -34 dBm0		33.5		
	Level = -40 dBm0		28.5		
	Level = -55 dBm0		13.5		
Signal-to-distortion ratio, receive half-channel (A-law) (CCITT G.714)§	Level = -3 dBm0		33		dB
	Level = $-6$ dBm0 to $-27$ dBm0		36		
	Level = -34 dBm0		34.2		
	Level = -40 dBm0		30		
	Level = -55 dBm0		15		

<sup>†</sup>The unit dBC applies to C-message weighting.

NOTE 6: The TP3054A and TP13054A are measured using a C-message weighted filter. The TP3057A and TP13057A are measured using a psophometric weighted filter.



<sup>‡</sup> Sinusoidal test method (see Note 6)

<sup>§</sup> Pseudo-noise test method

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#### crosstalk

PARAMETER	TEST CONDITIONS		MIN	TYP <sup>†</sup>	MAX	UNIT
Crosstalk, transmit to receive	f = 300 Hz to 3000 Hz,	DR at steady PCM code		-90	-75	dB
Crosstalk, receive to transmit (see Note 7)	VFXI = 0 V,	f = 300 Hz to 3000 Hz		-90	-75	dB

† All typical values are at  $V_{CC}$  = 5 V,  $V_{BB}$  = -5 V, and  $T_A$  = 25°C. NOTE 7: Receive-to-transmit crosstalk is measured with a - 50 dBm0 activation signal applied at VFXI+.

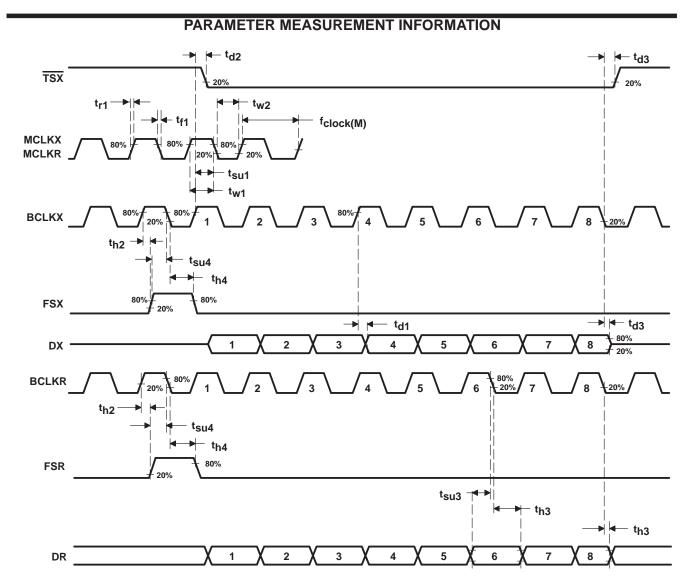


Figure 1. Short-Frame Sync Timing



#### PARAMETER MEASUREMENT INFORMATION

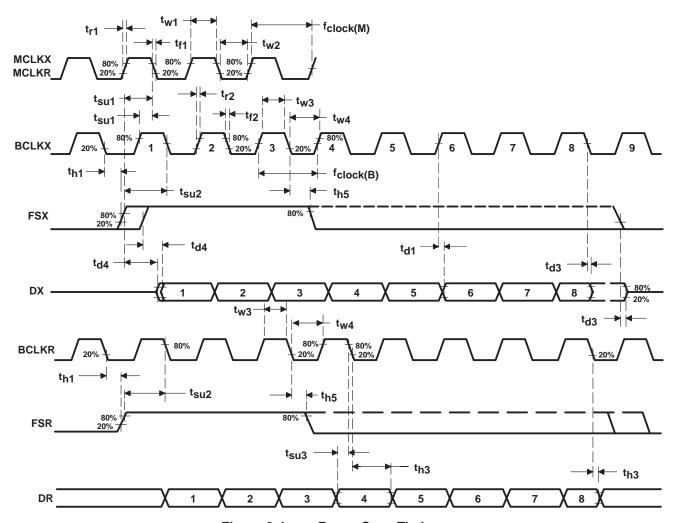


Figure 2. Long-Frame Sync Timing

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#### PRINCIPLES OF OPERATION

#### system reliability and design considerations

TP305xA, TP1305xA system reliability and design considerations are described in the following paragraphs.

#### latch-up

Latch-up is possible in all CMOS devices. It is caused by the firing of a parasitic SCR that is present due to the inherent nature of CMOS. When a latch-up occurs, the device draws excessive amounts of current and will continue to draw heavy current until power is removed. Latch-up can result in permanent damage to the device if supply current to the device is not limited.

Even though the TP305xA and TP1305xA are heavily protected against latch-up, it is still possible to cause latch-up under certain conditions in which excess current is forced into or out of one or more terminals. Latch-up can occur when the positive supply voltage drops momentarily below ground, when the negative supply voltage rises momentarily above ground, or possibly if a signal is applied to a terminal after power has been applied but before the ground is connected. This can happen if the device is hot-inserted into a card with the power applied, or if the device is mounted on a card that has an edge connector and the card is hot-inserted into a system with the power on.

To help ensure that latch-up does not occur, it is considered good design practice to connect a reverse-biased Schottky diode (with a forward voltage drop of less than or equal to 0.4 V - 1N5711 or equivalent) between the power supply and GND (see Figure 3). If it is possible that a TP305xA- or TP1305xA-equipped card that has an edge connector could be hot-inserted into a powered-up system, it is also important to ensure that the ground edge connector traces are longer than the power and signal traces so that the card ground is always the first to make contact.

#### device power-up sequence

Latch-up can also occur if a signal source is connected without the device being properly grounded. A signal applied to one terminal could then find a ground through another signal terminal on the device. To ensure proper operation of the device and as a safeguard against this sort of latch-up, it is recommended that the following power-up sequence always be used:

- 1. Ensure that no signals are applied to the device before the power-up sequence is complete.
- 2. Connect GND.
- 3. Apply V<sub>BR</sub> (most negative voltage).
- 4. Apply V<sub>CC</sub> (most positive voltage).
- 5. Force a power down condition in the device.
- 6. Connect clocks.
- 7. Release the power down condition.
- 8. Apply FS synchronization pulses.
- 9. Apply the signal inputs.

When powering down the device, this procedure should be followed in the reverse order.



#### PRINCIPLES OF OPERATION

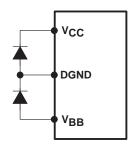


Figure 3. Latch-Up Protection Diode Connection

#### internal sequencing

Power-on reset circuitry initializes the TP3054A, TP3057A, TP13054A, and TP13057A devices when power is first applied, placing it into the power-down mode. DX and VFRO outputs go into high-impedance states and all nonessential circuitry is disabled. A low level or clock applied to MCLKR/PDN powers up the device and activates all circuits. DX, a 3-state PCM data output, remains in the high-impedance state until the arrival of the second FSX pulse.

#### synchronous operation

For synchronous operation, a clock is applied to MCLKX. MCLKR/PDN is used as a power-down control. A low level on MCLKR powers up the device and a high level powers it down. In either case, MCLKX is selected as the master clock for both receive and transmit direction. BCLKX must also have a bit clock applied to it. The selection of the proper internal divider for a master-clock frequency of 1.536 MHz, 1.544 MHz, or 2.048 MHz can be done via BCLKR/CLKSEL. The device automatically compensates for the 193rd clock pulse of each frame.

A fixed level on BCLKR/CLKSEL selects BCLKX as the bit clock for both the transmit and receive directions. Table 1 indicates the frequencies of operation that can be selected depending on the state of BCLKR/CLKSEL. In the synchronous mode, BCLKX may be in the range from 64 kHz to 2.048 MHz but must be synchronous with MCLKX.

 MASTER-CLOCK FREQUENCY SELECTED

 TP13054A, TP3054A
 TP13057A, TP3057A

 Clock Input
 1.536 MHz or 1.544 MHz
 2.048 MHz

 Logic Input L (sync mode only)
 2.048 MHz
 1.536 MHz or 1.544 MHz

 Logic Input H (open) (sync mode only)
 1.536 MHz or 1.544 MHz
 2.048 MHz

**Table 1. Selection of Master-Clock Frequencies** 

The encoding cycle begins with each FSX pulse and the PCM data from the previous cycle is shifted out of the enabled DX output on the rising edge of BCLKX. After eight bit-clock periods, the 3-state DX output is returned to the high-impedance state. With an FSR pulse, PCM data is latched via DR on the falling edge of BCLKX (or BCLKR, if running). FSX and FSR must be synchronous with MCLKX and MCLKR.

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#### PRINCIPLES OF OPERATION

#### asynchronous operation

For asynchronous operation, separate transmit and receive clocks can be applied. MCLKX and MCLKR must be 2.048 MHz for the TP3057A and TP13057A, 1.536 MHz or 1.544 MHz for the TP3054A and TP13054A and need not be synchronous. However, for best performance, MCLKR should be synchronous with MCLKX. This is easily achieved by applying only static logic levels to MCLKR/PDN. This connects MCLKX to all internal MCLKR functions. For 1.544-MHz operation, the device compensates for the 193rd clock pulse of each frame. Each encoding cycle is started with FSX and FSX must be synchronous with MCLKX and BCLKX. Each decoding cycle is started with FSR and FSR must be synchronous with BCLKR. The logic levels shown in Table 1 are not valid in the asynchronous mode. BCLKX and BCLKR can operate from 64 kHz to 2.048 MHz.

#### short-frame sync operation

The device can operate with either a short- or a long-frame sync pulse. On power up, the device automatically goes into the short-frame mode where both FSX and FSR must be one bit-clock period long with timing relationships specified in Figure 1. With FSX high during a falling edge of BCLKX, the next rising edge of BCLKX enables the 3-state output buffer, DX, which outputs the sign bit. The remaining seven bits are clocked out on the following seven rising edges, and the next falling edge disables DX. With FSR high during a falling edge of BCLKR (BCLKX in synchronous mode), the next falling edge of BCLKR latches in the sign bit. The following seven falling edges latch in the seven remaining bits. The short-frame sync pulse may be utilized in either the synchronous or asynchronous mode.

#### long-frame sync operation

Both FSX and FSR must be three or more bit-clock periods long to use the long-frame sync mode with timing relationships as shown in Figure 2. Using the transmit frame sync (FSX), the device detects whether a short-or long-frame sync pulse is being used. For 64-kHz operation, the frame-sync pulse must be kept low for a minimum of 160 ns. The rising edge of FSX or BCLKX, whichever occurs later, enables the DX 3-state output buffer. The first bit clocked out is the sign bit. The next seven rising edges of BCLKX edges clock out the remaining seven bits. The falling edge of BCLKX following the eighth rising edge or FSX going low, whichever occurs later, disables DX. A rising edge on FSR, the receive-frame sync pulse, causes the PCM data at DR to be latched in on the next eight falling edges of BCLKR (BCLKX in synchronous mode). The long-frame sync pulse can be utilized in either the synchronous or asynchronous mode.

#### transmit section

The transmit section input is an operational amplifier with provision for gain adjustment using two external resistors. The low noise and wide bandwidth characteristics of these devices provide gains in excess of 20 dB across the audio passband. The operational amplifier drives a unity-gain filter consisting of an RC active prefilter followed by an eighth-order switched-capacitor band-pass filter clocked at 256 kHz. The output of this filter directly drives the encoder sample-and-hold circuit. As per  $\mu$ -law (TP3054A and TP13054A) or A-law (TP3057A and TP13057A) coding conventions, the ADC is a companding type. A precision voltage reference provides a nominal input overload ( $t_{\mbox{\scriptsize [max]}}$ ) of nominally 2.5 V peak. The sampling of the filter output is controlled by the FSX frame-sync pulse. Then the successive-approximation encoding cycle begins. The 8-bit code is loaded into a buffer and shifted out through DX at the next FSX pulse. The total encoding delay is approximately 290  $\mu$ s. Any offset voltage due to the filters or comparator is cancelled by sign-bit integration.



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#### PRINCIPLES OF OPERATION

#### receive section

The receive section consists of an expanding DAC that drives a fifth-order low-pass filter clocked at 256 kHz. The decoder is  $\mu$ -law (TP3054A and TP13054A) or A-law (TP3057A and TP13057A) and the fifth-order low-pass filter corrects for the (sin x)/x attenuation caused by the 8-kHz sample/hold. The filter is followed by a second-order RC active post-filter/power amplifier capable of driving a 600- $\Omega$  load to a level of 7.2 dBm. The receive section is unity gain. At FSR, the data at DR is clocked in on the falling edge of the next eight BCLKR (BCLKX) periods. At the end of the decoder time slot, the decoding cycle begins and 10  $\mu$ s later, the decoder DAC output is updated. The decoder delay is about 10  $\mu$ s (decoder update) plus 110  $\mu$ s (filter delay) plus 62.5  $\mu$ s (1/2 frame), or a total of approximately 180  $\mu$ s.



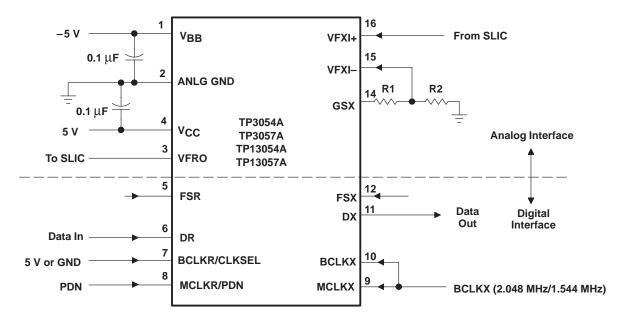
#### **APPLICATION INFORMATION**

#### power supplies

While the pins of the TP1305xA and TP305xA families are well protected against electrical misuse, it is recommended that the standard CMOS practice be followed ensuring that ground is connected to the device before any other connections are made. In applications where the printed-circuit board can be plugged into a hot socket with power and clocks already present, an extra long ground pin in the connector should be used.

All ground connections to each device should meet at a common point as close as possible to ANLG GND. This minimizes the interaction of ground return currents flowing through a common bus impedance.  $V_{CC}$  and  $V_{BB}$  supplies should be decoupled by connecting 0.1- $\mu$ F decoupling capacitors to this common point. These bypass capacitors must be connected as close as possible to  $V_{CC}$  and  $V_{BB}$ .

For best performance, the ground point of each codec/filter on a card should be connected to a common card ground in star formation rather than via a ground bus. This common ground point should be decoupled to  $V_{CC}$  and  $V_{BB}$  with 10- $\mu F$  capacitors.



NOTE A: Transmit gain = 20 log  $\left(\frac{R1 + R2}{R2}\right)$ ,  $\left(R1 + R2\right) \ge 10 \text{ k}\Omega$ 

Figure 4. Typical Synchronous Application



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